



Products | Liquid Solder Flux | 186 Flux-Pen®

# **PRODUCTS**



### 186 Flux-Pen®

Kester 186 Flux-Pen® is specifically designed for leaded and lead-free rework of conventional and surface mount circuit board assemblies. 186 under MIL-F-14256, was QPL approved as Type RMA. Although the fluxing ability approaches that of Type RA flux, residues after soldering are non-corrosive and non-conductive. 186 has been developed for use in critical applications where difficult assemblies are to be soldered, but process requirements stipulate use of Type RMA flux. 186 possesses high thermal stability for soldering multi-layer assemblies which require higher temperatures. Exposure to high preheat temperatures does not degrade solubility of the residue in normal cleaning solvents. There is no surface insulation resistance degradation caused by the flux residue. The use of a minimum of ionic activating agents and the inactive nature of the residue permits leaving the residue on circuit board assemblies for many applications. The flux residue is also moisture and fungus resistant.

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**Product Offerings** 

**Data Sheets and SDS** 

Halogen Content	Description	Part #	Туре	Flux Type
Contains Halogen	186 Flux-Pen 20 CTN	8310000186	Rosin	Rosin Activated

## **Process Compatible Products**

186 Soldering Flux



285 Flux-Cored Wire



44 Flux-Cored Wire







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#### **PRODUCTS**

Solder Wire Liquid Solder Flux Solder Paste Tacky Solder Flux Preforms Bar Solder Search... Q Element Solutions Inc.

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